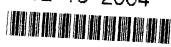
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U.S. DEPARTMENT OF COMMERCE U.S. Patent and Trademark Office

OMB No. 0651-0027 (exp. 6/30/2008 102899667 Attorney Docket No. 501.44392X00 To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof. 1. Name of conveying party(ies): 2. Name and address of receiving party(ies) Mitsuru KINOSHITA Name: RENESAS TECHNOLOGY CORP. Tsugihiko HIRANO Katsunori TAKAHASHI Street Address: 4-1, Marunouchi 2-chome, Additional name(s) of conveying party(ies) attached? \square Yes \boxtimes No Chiyoda-ku, Tokyo, JAPAN 3. Nature of conveyance: Assignment Assignment ☐ Merger ☐ Change of Name Security Agreement Other . Additional name(s) & address(es) attached?

Yes

No Execution Date: Sept. 21, 2004. 4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is: Sept. 21, 2004. A. Patent Application No.(s) B. Patent Registration No.(s) Additional number(s) attached Tyes No 5. Name and address of party to whom correspondence 6. Total number of applications and patents involved concerning document should be mailed: 7. Total fee (37 CFR 3.41)..... \$40.00 Name: ANTONELLI, TERRY, STOUT & KRAUS, LLP Internal Address: Authorized to be charged to deposit account 1300 NORTH 17TH STREET - SUITE 1800 8. Deposit account number: City: ARLINGTON State: VA Zip 22209 01-2135 (Attach duplicate copy of this page if paying by deposit account) DO NOT USE THIS SPACE 9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. WILLIAM I. SOLOMON, Reg. #28,565 12/03/2004 Name of Person Signing Date Total number of pages including cover sheet, attachments, and document:

Mail documents to be recorded with required cover sheet information to: Commissioner of Patent & Trademarks, Box Assignments Washington, D.C. 20231

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PATENT REEL: 016054 FRAME: 0621

ASSIGNMENT (譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Renesas Technology Corp., a corporation organized under the laws of Japan,

located at 4-1, Marunouchi 2-chome, Chiyoda-ku, Tokyo, Japan,

receipt of which is hereby acknowledged I do hereby sell and assign to said Renesas Technology Corp., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

ELECTROPLATING METHOD FOR A SEMICONDUCTOR DEVICE

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said Renesas Technology Corp.,

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Renesas Technology Corp.,

Signed on the date(s) indicated aside our signatures:

RECORDED: 12/03/2004

INVENTOR(S) (発明者フルネームサイン) Date Signed (署名日)

1) Mitsuru KINDSHITA Mitsuru KINOSHITA	21/Soptember/2004
2) Tsugihiko Hirano Tsugihiko HIRANO	21/September/2004
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4)	
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PATENT REEL: 016054 FRAME: 0622